

RS723Q-E11-RS24

Great Scalability and High Performance Computing (HPC) Multi-Node Server with Direct to Chip Liquid Cooling Solution



ASUS RS723Q-E11-RS24 is the ideal multi-node server powered by 4th Gen Intel® Xeon Scalable processors, with each node supporting up to 16 DIMM, three PCIe® 5.0 slot and two M.2, and a total of eight NVMe/SAS/SATA drives.

FEATURE

- Powered by dual-socket 4th Gen Intel Scalable processors with DDR4 Memory up to 4800MHz Family with 16 DDR5 Memory up to 4800MHz, and designed for the demand of
- Multi-Node Server with Immersion Cooling Solution
- Two PCIe 5.0 x16 slot module per node

Onboard ASUS ASMB11-iKVM

ASPEED AST2600 controller

24 x 2.5" Hot-swap Drive Bays support 8 x NVMe 3600W 80 Plus® Titanium power supplies

4th Gen Intel Xeon Scalable processors

Direct to Chip Liquid Cooling Solution

ASUS Direct to Chip Liquid cooling is another highly-effective solution from ASUS. This technique offers more advantages on PUE and encompasses higher-density servers. However, it also demands more space, and may require retooling of the data-center infrastructure. But Direct to Chip Liquid cooling can control temperatures more rapidly, efficiently and cost-effectively than traditional methods. For users of supercomputers in particular, immersion cooling is the preferred option.

The RS720Q-E11-RS8U is built with the latest Intel® Xeon® Processor Scalable

high scalability, high density computing, and wide range of existing and emerging

PCIe 5.0 Ready

workloads.

PCI Express[®] (PCIe[®]) 5.0 delivers 16 GT/s bandwidth, which is double the speed of PCle 4.0, offering lower power consumption, better lane scalability and backwards compatibility.

Enhanced Security

PFR FPGA as the platform Root-of-Trust solution for firmware resiliency Trusted Platform Module 2.0 (TPM 2.0) to secure hardware through integrated cryptographic keys and offer regular firmware update for vulnerabilities.



RS723Q-E11-RS24 Processor Support



SPECIFICATION

5/23Q-E11-K524		SPECIFICATION
Processor Support		4th Gen Intel® Xeon® processor Scalable family (with D2C Liquid cool up to 350W, Air cool solution will launch in 23, Q4) UPI 16 GT/s
Core Logic		Intel [®] C741 PCH
Memory	Total Slots	16 (8-channel per CPU, 8 DIMM per CPU)
-	Capacity	Maximum up to 8192GB per Node
	Memory Type	DDR5 4800 RDIMM/RDIMM 3DS (1DIMM per Channel)
		512GB, 256GB, 128GB Intel® Optane™ persistent memory 300 series (Crow Pass)
		*Refer to Asus server AVL for the latest update
	Memory Size	64GB, 32GB, 16GB RDIMM
		256GB, 128GB RDIMM 3DS * Refer to www.asus.com/support for more information
Expansion Slots	Slot Type	Per node: up to 2+1 slots
		1 x PCI-E x16 (Gen5 x16 link), LP (HHHL)
		1 x PCI-E x8 (Gen5 x8 link), LP (HHHL), optional
		1 x OCP 3.0 Mezzanine (Gen5 x16 link)
Disk Controller	SATA Controller	The Same as SAS Controller
	SAS Controller	Per Node:
		ASUS CB8LX12G-R2H-B (Support RAID 0, 1) - 2 x SAS 12Gb/s ports or
		- 2 x SATA 6Gb/s ports
	NVMe Controller	The Same as SAS Controller
Storage Bays	I = internal	24 x 2.5" Hot-swap Storage Bays
	A or S will be hot-swappable	(8 x SATA/SAS/NVMe + 16 x SATA/SAS supported)
		* ASUS CB8LX12G-R2H-B is required to support SATA/SAS hard drives
Networking	LAN	Per Node: 2 x Intel i210 1 Gigabit LAN Controller
		1 x Management Port
Graphic	VGA	Aspeed AST2600 64MB
Front I/O Ports		N/A
Rear I/O Ports		Per Node:
		1 x USB 3.1 Gen1 ports
		1 x mini Display port
		1 x RJ-45 1GbE LAN ports 1 x RJ-45 Mgmt LAN port
Switch/LED		Per Node:
		Front:
		- 1 x Power Switch/LED
		- 1 x Location Switch/LED
		- 1 x Message LED - 2 x LAN LED
		- 2 X LAN LED Rear:
		- 1 x Power Switch/LED
OS Support		Please find the latest OS support from http://www.asus.com/
Management	Software	ASUS Control Center (Classic)
Solution	Out of Band Remote Management	On-Board ASM11-iKVM for KVM-over-IP
Dimension		890mm x 444mm x 88mm (2U), 35.04" x 17.48" x 3.46"
Net Weight Kg (CPU, DRAM & HDD not included)		35.5 Кg
Gross Weight Kg (CPU, DRAM & HDD not included, Packing included)		41.5 Кg
Power Supply		1+1 Redundant 3000W 80 PLUS Titanium Power Supply
(tollowing different	t configuration by region)	Rating: 220-240 Vac, 15.5A (x2), 50-60Hz, Class I
		1+1 Redundant 3600W 80 PLUS Titanium Power Supply 220V-240Vac, 10A (X2), 50HZ-60HZ, Class I
		* 1+1 Redundant mode only supports CPUs under 205W
Environment		Operation temperature: 10° C ~ 35° C
		Non operation temperature: $-40^{\circ}C \sim 70^{\circ}C$
		Non operation humidity: 20% ~ 90% (Non condensing)